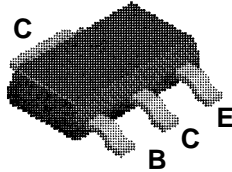


## FZT649



**SOT-223**

### NPN Low Saturation Transistor

These devices are designed with high current gain and low saturation voltage with collector currents up to 3A continuous.

#### Absolute Maximum Ratings\*

$T_A = 25^\circ\text{C}$  unless otherwise noted

| Symbol         | Parameter  | FZT649      | Units            |
|----------------|--|-------------|------------------|
| $V_{CEO}$      | Collector-Emitter Voltage                        | 25          | V                |
| $V_{CBO}$      | Collector-Base Voltage                           | 35          | V                |
| $V_{EBO}$      | Emitter-Base Voltage                             | 5           | V                |
| $I_C$          | Collector Current - Continuous                   | 3           | A                |
| $T_J, T_{stg}$ | Operating and Storage Junction Temperature Range | -55 to +150 | $^\circ\text{C}$ |

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### NOTES:

- 1) These ratings are based on a maximum junction temperature of  $150^\circ\text{C}$ .
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

#### Thermal Characteristics

$T_A = 25^\circ\text{C}$  unless otherwise noted

| Symbol          | Characteristic                          | Max    | Units              |
|-----------------|---|--------|--------------------|
|                 |   | FZT649 |                    |
| $P_D$           | Total Device Dissipation                | 2      | W                  |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 62.5   | $^\circ\text{C/W}$ |

**NPN Low Saturation Transistor**

(continued)

**Electrical Characteristics** $T_A = 25^\circ\text{C}$  unless otherwise noted

| Symbol                              | Parameter                            | Test Conditions  | Min                   | Max        | Units               |
|-------------------------------------|--------------------------------------|--|-----------------------|------------|---------------------|
| <b>OFF CHARACTERISTICS</b>          |                                      |  |                       |            |                     |
| $BV_{CEO}$                          | Collector-Emitter Breakdown Voltage  | $I_C = 10\text{ mA}$   | 25                    |            | V                   |
| $BV_{CBO}$                          | Collector-Base Breakdown Voltage     | $I_C = 100\text{ }\mu\text{A}$   | 35                    |            | V                   |
| $BV_{EBO}$                          | Emitter-Base Breakdown Voltage       | $I_E = 100\text{ }\mu\text{A}$   | 5                     |            | V                   |
| $I_{CBO}$                           | Collector Cutoff Current             | $V_{CB} = 30\text{ V}$<br>$V_{CB} = 30\text{ V}, T_A = 100^\circ\text{C}$  |                       | 100<br>10  | nA<br>$\mu\text{A}$ |
| $I_{EBO}$                           | Emitter Cutoff Current               | $V_{EB} = 4\text{ V}$  |                       | 100        | nA                  |
| <b>ON CHARACTERISTICS*</b>          |                                      |  |                       |            |                     |
| $h_{FE}$                            | DC Current Gain                      | $I_C = 50\text{ mA}, V_{CE} = 2\text{ V}$<br>$I_C = 1\text{ A}, V_{CE} = 2\text{ V}$<br>$I_C = 2\text{ A}, V_{CE} = 2\text{ V}$<br>$I_C = 6\text{ A}, V_{CE} = 2\text{ V}$ | 70<br>100<br>75<br>15 | 300        | -                   |
| $V_{CE(sat)}$                       | Collector-Emitter Saturation Voltage | $I_C = 1\text{ A}, I_B = 100\text{ mA}$<br>$I_C = 3\text{ A}, I_B = 300\text{ mA}$   |                       | 300<br>600 | mV                  |
| $V_{BE(sat)}$                       | Base-Emitter Saturation Voltage      | $I_C = 1\text{ A}, I_B = 100\text{ mA}$  |                       | 1.25       | V                   |
| $V_{BE(on)}$                        | Base-Emitter On Voltage              | $I_C = 1\text{ A}, V_{CE} = 2\text{ V}$  |                       | 1          | V                   |
| <b>SMALL SIGNAL CHARACTERISTICS</b> |                                      |  |                       |            |                     |
| $C_{obo}$                           | Output Capacitance                   | $V_{CB} = 10\text{ V}, I_E = 0, f = 1\text{ MHz}$  |                       | 50         | pF                  |
| $f_T$                               | Transition Frequency                 | $I_C = 100\text{ mA}, V_{CE} = 5\text{ V}, f = 100\text{ MHz}$   | 150                   |            | -                   |

\*Pulse Test: Pulse Width  $\leq 300\text{ }\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$

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